

SMD Type

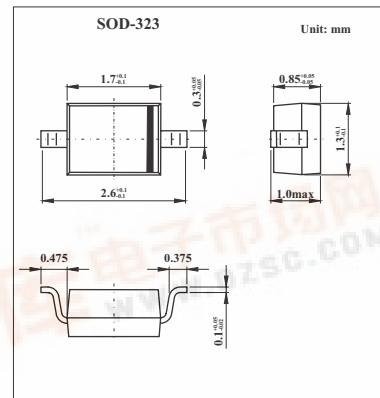
Diodes

Surface Mount Fast Switching Diodes

1N4448WS

■ Features

- Fast Switching Speed
- Ultra-Small Surface Mount Package
- For General Purpose Switching Applications
- High Conductance



■ Absolute Maximum Ratings Ta = 25°C

Parameter	Symbol	Rating	Unit
Non-Repetitive Peak Reverse Voltage	V _{RM}	100	V
Peak Repetitive Reverse Voltage	V _{R_{RM}}		
Working Peak Reverse Voltage	V _{R_{WM}}	75	V
DC Blocking Voltage	V _R		
RMS Reverse Voltage	V _{R(RMS)}	53	V
Forward Continuous Current	I _{FM}	500	mA
Average Rectified Output Current	I _O	250	mA
Non-Repetitive Peak Forward Surge Current @ t = 1.0 μ s @ t = 1.0s	I _{FSM}	4.0 2.0	A
Power Dissipation	P _D	200	mW
Thermal Resistance Junction to Ambient Air	R _{θ JA}	625	°C/W
Operating and Storage Temperature Range	T _{j, T_{STG}}	-65 to +150	°C

1N4448WS■ Electrical Characteristics $T_a = 25^\circ\text{C}$

Parameter	Symbol	Testconditons	Min	Typ	Max	Unit
Reverse Breakdown Voltage (*)	$V_{(BR)R}$	$I_R = 2.5 \mu\text{A}$	75			V
Forward Voltage (*)	V_F	$I_F = 5.0\text{mA}$	0.62		0.72	V
		$I_F = 10\text{mA}$			0.855	
		$I_F = 100\text{mA}$			1.0	
		$I_F = 150\text{mA}$			1.25	
Leakage Current (*)	I_R	$V_R = 75\text{V}$			2.5	μA
		$V_R = 75\text{V}, T_j = 150^\circ\text{C}$			50	
		$V_R = 25\text{V}, T_j = 150^\circ\text{C}$			30	
		$V_R = 20\text{V}$			25	
Total Capacitance	C_T	$V_R = 0, f = 1.0\text{MHz}$			4.0	pF
Reverse Recovery Time	t_{rr}	$I_F = I_R = 10\text{mA}, I_{rr} = 0.1 \times I_R, R_L = 100 \Omega$			4.0	ns

* Short duration test pulse used to minimize self-heating effect.

■ Marking

Marking	T5
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